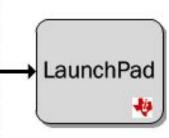
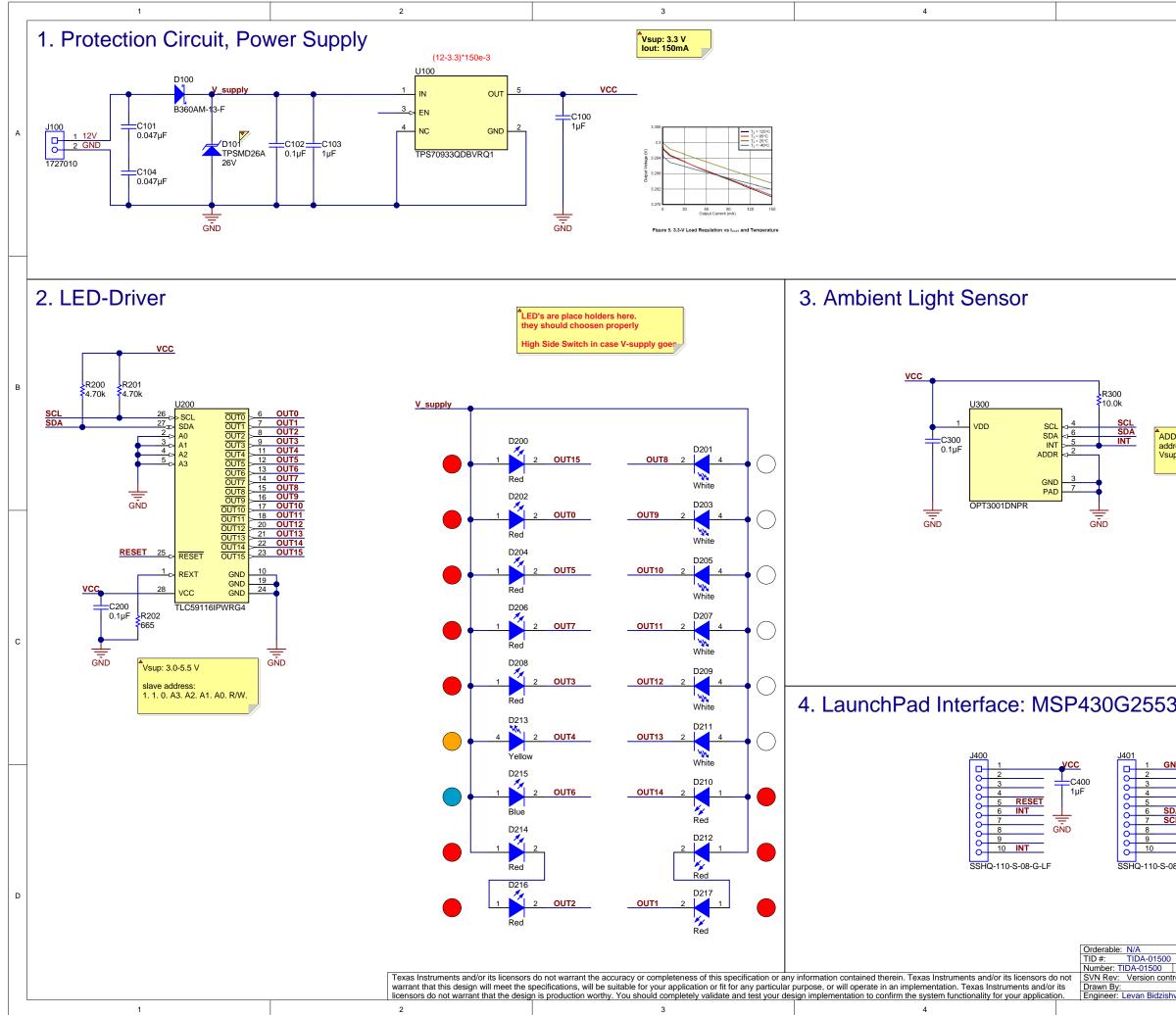
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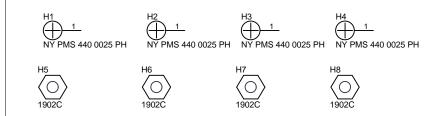






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## X X X

PCB Number: TIDA-01500 PCB Rev: E1

PCB LOGO Texas Instruments

PCB LOGO FCC disclaimer Pb-Free Symbol

PCB LOGO

LBL1 PCB Label Size: 0.65" x 0.20 "

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ZZ1 Label Assembly Note This Assembly Note is for PCB labels only

ZZ2 Assembly Note These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
<u>Assembly Note</u>
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

1

ZZ4 Assembly Note These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

 
 Orderable:
 N/A
 Designed for:
 Public Release
 Mod. Date:
 11/7/2017

 TID #:
 TIDA-01500
 Project Title:
 Automotive Multi Channel LED Driver for HVAC HM

 Number:
 TIDA-01500
 Rev:
 E1
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